PHP20N06T



N-channel TrenchMOS standard level FET

Rev. 02 — 27 November 2009

Product data sheet

1. Product profile

1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product is designed and qualified for use in computing, communications, consumer and industrial applications only.

1.2 Features and benefits

- Low conduction losses due to low on-state resistance
- Suitable for high frequency applications due to fast switching characteristics

1.3 Applications

DC-to-DC convertors

Switched-mode power supplies

1.4 Quick reference data

Table 1. Quick reference

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-------------------|-------------------------------------|--|-----|-----|------|------|
| V_{DS} | drain-source voltage | T _j ≥ 25 °C; T _j ≤ 175 °C | - | - | 55 | V |
| I_D | drain current | T_{mb} = 25 °C; V_{GS} = 10 V; see <u>Figure 3</u> and <u>1</u> | - | - | 20.3 | Α |
| P _{tot} | total power dissipation | T _{mb} = 25 °C;see <u>Figure 2</u> | - | - | 62 | W |
| Dynamic | characteristics | | | | | |
| Q_{GD} | gate-drain charge | $V_{GS} = 10 \text{ V}; I_D = 25 \text{ A};$ $V_{DS} = 44 \text{ V}; T_j = 25 \text{ °C};$ see Figure 13 | - | 6 | - | nC |
| Static ch | aracteristics | | | | | |
| R _{DSon} | drain-source on-state resistance | $V_{GS} = 10 \text{ V}; I_D = 10 \text{ A};$ $T_j = 175 \text{ °C};$ see Figure 11 and 12 | - | - | 150 | mΩ |
| | | $V_{GS} = 10 \text{ V}; I_D = 10 \text{ A};$ $T_j = 25 \text{ °C};$ see Figure 11 and 12 | - | 64 | 75 | mΩ |



2. Pinning information

Table 2. Pinning information

| | 9 | | | |
|-----|--------|-----------------------------------|--------------------|-----------------------|
| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| 1 | G | gate | | |
| 2 | D | drain | mb | D |
| 3 | S | source | | $G \longrightarrow X$ |
| | D | mounting base; connected to drain | 1 2 3 | mbb076 S |
| | | | SOT78 (TO-220AB) | |

3. Ordering information

Table 3. Ordering information

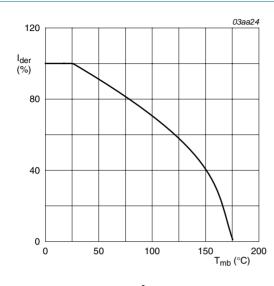
| Type number | Package | | |
|-------------|----------|--|---------|
| | Name | Description | Version |
| PHP20N06T | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78 |

4. Limiting values

Table 4. Limiting values

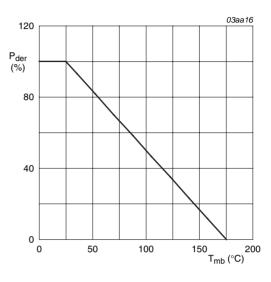
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|----------------------|--|---|-----|------|------|
| V_{DS} | drain-source voltage | $T_j \ge 25 ^{\circ}\text{C}; T_j \le 175 ^{\circ}\text{C}$ | - | 55 | V |
| V_{DGR} | drain-gate voltage | $R_{GS} = 20 \text{ k}\Omega$ | - | 55 | V |
| V_{GS} | gate-source voltage | | -20 | 20 | V |
| I_D | drain current | V _{GS} = 10 V; T _{mb} = 100 °C; see <u>Figure 1</u> | - | 14.3 | Α |
| | | $V_{GS} = 10 \text{ V}; T_{mb} = 25 \text{ °C}; \text{ see } \frac{\text{Figure 3}}{\text{Mode } 100 \text{ Figure } 100 } \text{ and } \frac{1}{100 }$ | - | 20.3 | Α |
| I_{DM} | peak drain current | $t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$; see Figure 3 | - | 81 | Α |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; see <u>Figure 2</u> | - | 62 | W |
| T _{stg} | storage temperature | | -55 | 175 | °C |
| Tj | junction temperature | | -55 | 175 | °C |
| Source-dr | ain diode | | | | |
| I _S | source current | $T_{mb} = 25 ^{\circ}C$ | - | 20.3 | Α |
| I _{SM} | peak source current | $t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$ | - | 81 | Α |
| Avalanche | ruggedness | | | | |
| E _{DS(AL)S} | non-repetitive drain-source avalanche energy | V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_D = 11 A; $V_{sup} \le$ 55 V; R_{GS} = 50 Ω; unclamped | - | 30.3 | mJ |



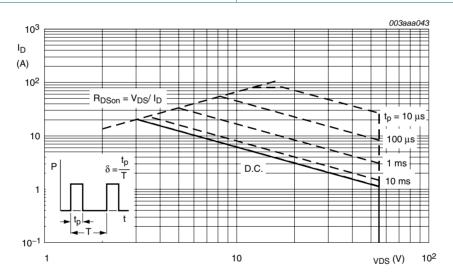
$$I_{der} = \frac{I_D}{I_{D(25^{\circ}C)}} \times 100\%$$

Fig 1. Normalized continuous drain current as a function of mounting base temperature



$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100\%$$

Fig 2. Normalized total power dissipation as a function of mounting base temperature



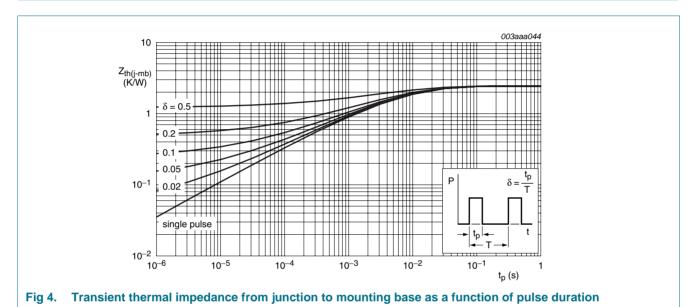
 $T_{mb} = 25$ °C; I_{DM} is single pulse

Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

5. Thermal characteristics

Table 5. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------|---|-----------------------|-----|-----|-----|------|
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base | see Figure 4 | - | - | 2.4 | K/W |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | vertical in still air | - | 60 | - | K/W |



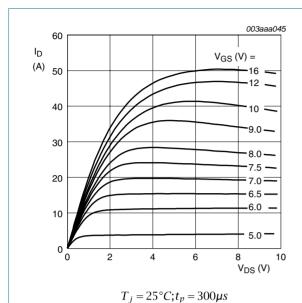
6. Characteristics

Table 6. Characteristics

| Table 6. | Characteristics | O Professional Professiona Professiona Professiona Professiona Professiona Professi | p | _ | | |
|--|---|--|-----|------|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| | racteristics | | | | | |
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = -55 \text{ °C}$ | 50 | - | - | V |
| | | $I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | 55 | - | - | V |
| V _{GS(th)} gate-source threshold voltage | gate-source threshold voltage | $I_D = 1 \text{ mA}$; $V_{DS} = V_{GS}$; $T_j = 175 \text{ °C}$; see <u>Figure 10</u> | 1 | - | - | V |
| | | I_D = 1 mA; V_{DS} = V_{GS} ; T_j = -55 °C; see <u>Figure 10</u> | - | - | 4.4 | V |
| | | $I_D = 1$ mA; $V_{DS} = V_{GS}$; $T_j = 25$ °C; see Figure 10 | 2 | 3 | 4 | V |
| I _{DSS} | drain leakage current | $V_{DS} = 55 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | - | 0.05 | 10 | μΑ |
| | | $V_{DS} = 55 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 175 ^{\circ}\text{C}$ | - | - | 500 | μΑ |
| I _{GSS} | gate leakage current | $V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | - | 2 | 100 | nA |
| | | $V_{GS} = -20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | - | 2 | 100 | nA |
| R _{DSon} drain-source on-state resistance | $V_{GS} = 10 \text{ V}; I_D = 10 \text{ A}; T_j = 175 ^{\circ}\text{C};$ see Figure 11 and 12 | - | - | 150 | mΩ | |
| | | $V_{GS} = 10 \text{ V}; I_D = 10 \text{ A}; T_j = 25 ^{\circ}\text{C};$ see Figure 11 and 12 | - | 64 | 75 | mΩ |
| Dynamic | characteristics | | | | | |
| Q _{G(tot)} | total gate charge | $I_D = 25 \text{ A}$; $V_{DS} = 44 \text{ V}$; $V_{GS} = 10 \text{ V}$; | - | 11 | - | nC |
| Q _{GS} | gate-source charge | T _j = 25 °C;see <u>Figure 13</u> | - | 3 | - | nC |
| Q_{GD} | gate-drain charge | | - | 6 | - | nC |
| C _{iss} | input capacitance | $V_{DS} = 25 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$ | - | 320 | 483 | pF |
| C _{oss} | output capacitance | T _j = 25 °C;see <u>Figure 14</u> | - | 92 | 113 | pF |
| C _{rss} | reverse transfer capacitance | | - | 64 | 90 | pF |
| t _{d(on)} | turn-on delay time | $V_{DS} = 30 \text{ V}; R_L = 1.2 \Omega; V_{GS} = 10 \text{ V};$ | - | 10 | - | ns |
| t _r | rise time | $R_{G(ext)} = 10 \Omega$; $T_j = 25 °C$ | - | 50 | - | ns |
| t _{d(off)} | turn-off delay time | | - | 70 | - | ns |
| t _f | fall time | | - | 40 | - | ns |
| L _D | internal drain inductance | from drain lead 6 mm from package to centre of die; T _i = 25 °C | - | 4.5 | - | nΗ |
| | | from contact screw on mounting base to centre of die; T _j = 25 °C | - | 3.5 | - | nΗ |
| L _S | internal source inductance | from source lead to source bond pad; $T_j = 25 ^{\circ}\text{C}$ | - | 7.5 | - | nΗ |
| Source-di | rain diode | | | | | |
| V_{SD} | source-drain voltage | $I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C};$ see <u>Figure 15</u> | - | 0.85 | 1.2 | V |
| t _{rr} | reverse recovery time | $I_S = 20 \text{ A}; dI_S/dt = -100 \text{ A/}\mu\text{s}; V_{GS} = -10 \text{ V};$ | - | 32 | - | ns |
| Q _r | recovered charge | $V_{DS} = 30 \text{ V}; T_j = 25 \text{ °C}$ | - | 120 | - | nC |

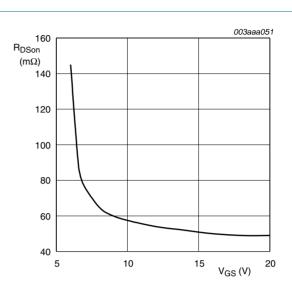
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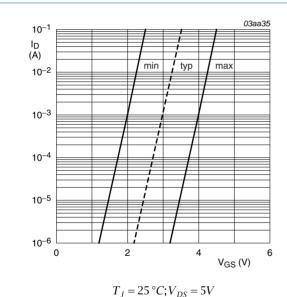
Output characteristics: drain current as a

function of drain-source voltage; typical values



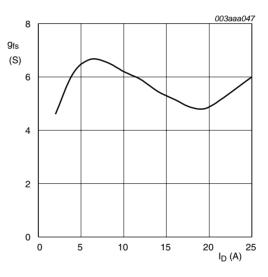
$$T_j = 25^{\circ}C; I_D = 25A$$

Fig 6. Drain-source on-state resistance as a function of gate-source voltage; typical values



g 7. Sub-threshold drain current as a function of

gate-source voltage



 $T_i = 25^{\circ}C; V_{DS} = 25V$

Fig 8. Forward transconductance as a function of drain current; typical values

Fig 5.

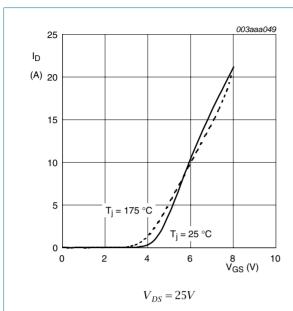
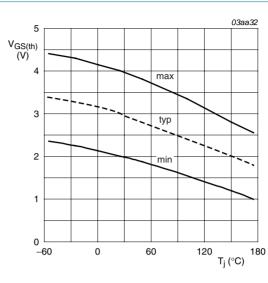


Fig 9. Transfer characteristics: drain current as a function of gate-source voltage; typical values



$$I_D = 1 \, mA; V_{DS} = V_{GS}$$

Fig 10. Gate-source threshold voltage as a function of junction temperature

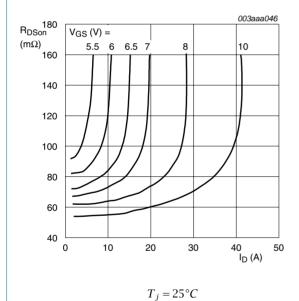


Fig 11. Drain-source on-state resistance as a function of drain current; typical values

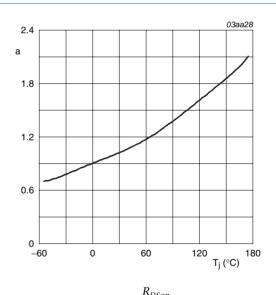


Fig 12. Normalized drain-source on-state resistance factor as a function of junction temperature

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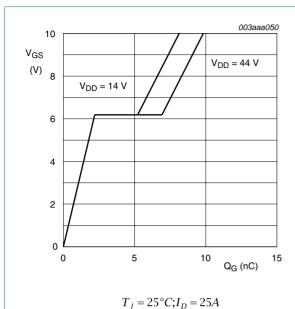
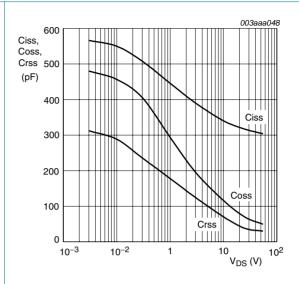
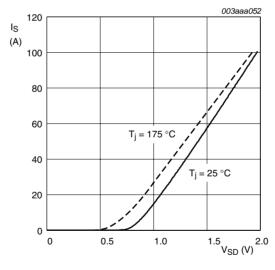


Fig 13. Gate-source voltage as a function of gate charge; typical values



$$V_{GS} = 0V; f = 1MHz$$

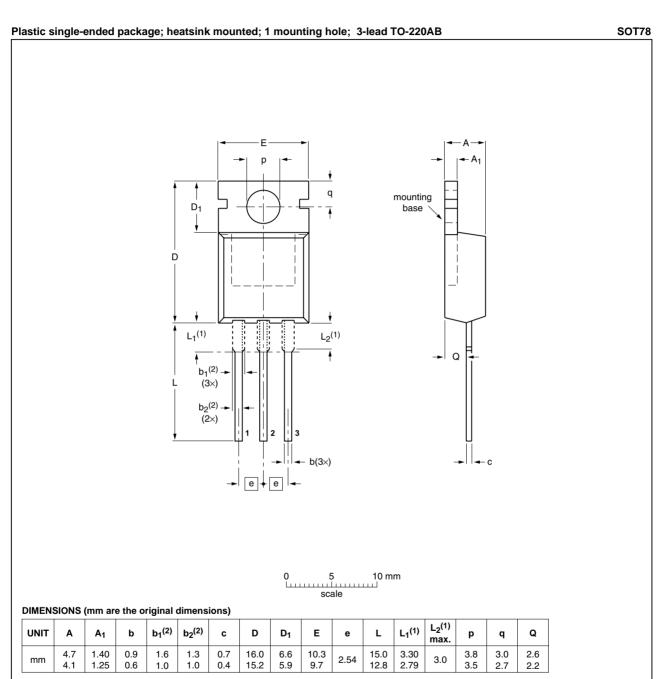
Fig 14. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values



 $V_{GS} = 0V$

Fig 15. Source current as a function of source-drain voltage; typical values

Package outline



- Lead shoulder designs may vary.
 Dimension includes excess dambar.

| OUTLINE | | REFER | ENCES | EUROPEAN ISSUE DA | ISSUE DATE |
|---------|-----|-----------------|-------|-------------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA | PROJECTION | ISSUE DATE |
| SOT78 | | 3-lead TO-220AB | SC-46 | | 08-04-23 08-06-13 |

Fig 16. Package outline SOT78 (TO-220AB)

8. Revision history

Table 7. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|------------------------|---------------------------------|--|--------------------|------------------------------|
| PHP20N06T_2 | 20091127 | Product data sheet | - | PHP20N06T_PHB20N06T-01 |
| Modifications: | | t of this data sheet has b of NXP Semiconductors | • | comply with the new identity |
| | Legal texts | s have been adapted to the | ne new company n | ame where appropriate. |
| | Type num | ber PHP20N06T separat | ed from data sheet | PHP20N06T_PHB20N06T-01. |
| PHP20N06T_PHB20N06T-01 | 20010222 | Product specification | - | - |

9. Legal information

9.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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